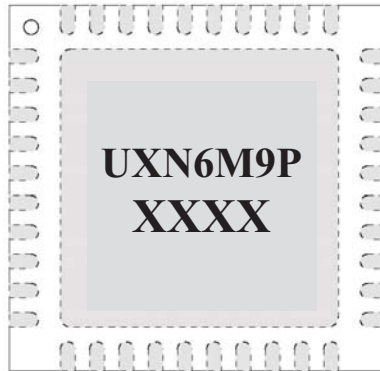


9 GHz Divide-by-8 to 511 Programmable Integer Divider

Features

- Wide Operating Range: DC - 9 GHz
- Contiguous Divide Ratios: 8 to 511
- Large Output Swings: >1 V_{pp}/side
- Single-Ended or Differential Drive
- Size: 6mm x 6mm
- Parallel Control Lines
- Low Power Consumption



40 pin Quad Flat No Lead (QFN)
6x6 mm pkg, 0.5mm pad pitch
JEDEC MO-220 Compliant

Marking Information:
UXN6M9P = Device Part Number
XXXX = Lot Code

Description

The UXN6M9P is a highly programmable integer divider covering all integer divide ratios between 8 and 511. The device features single-ended or differential inputs and outputs. Parallel control inputs are CMOS and LVTTTL compatible for ease of system integration. The UXN6M9P is packaged in a 40-pin, 6mm x 6mm lead-less plastic surface mount package.

Pad Metallization

The QFN package pad metallization consists of a 300-800 micro-inch (typical thickness 435 micro-inch or 11.04um) 100% matte Sn plate. The plating covers a Cu (C194) leadframe. The packages are manufactured with a >1hr 150C annealing/heat treating process, and the matte (non-glossy) plating, specifically to mitigate tin whisker growth.

Application

The UXN6M9P can be used as a low power, general purpose, highly configurable, divider in a variety of high frequency synthesizer applications. Fast switching combined with a wide range of divide ratios make the UXN6M9P an excellent choice for programmable frequency.

Key Specifications (T=25 °C)

V_{ee} = -3.3V, I_{ee} = 140mA, Z_i = 50 Ω , Z_o=100 Ω

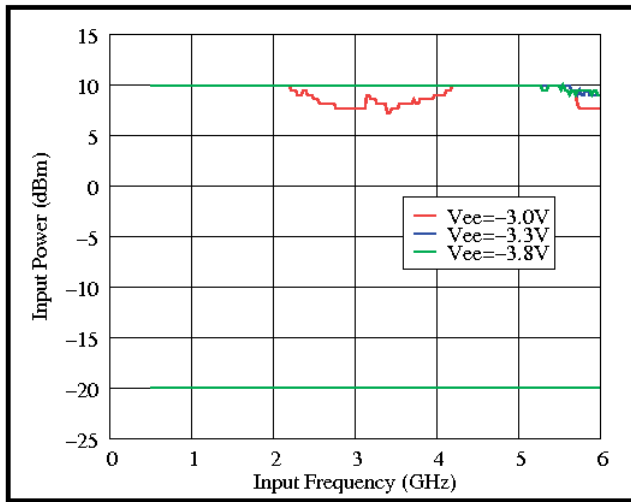
Parameter	Description	Minimum	Typical	Maximum
F _{in} (GHz)	Input Frequency	DC*	-	9**
P _{in} (dBm)	Input Power	-15	0	+5***
P _{out} (dBm)	Output Power	-	+4	-
P _{DC} (mW)	DC Power Dissipation	-	460	-
V _{ee} (V)	Negative DC Supply	-3.0	-3.3	-3.6

* Low frequency limit dependent on input edge speed

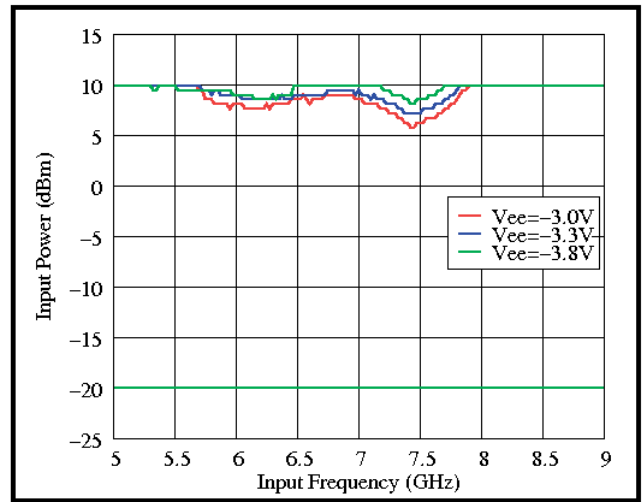
**Use FRS to extend frequency range beyond 6GHz. (see page 9)

***Operating Temperature = 25°C

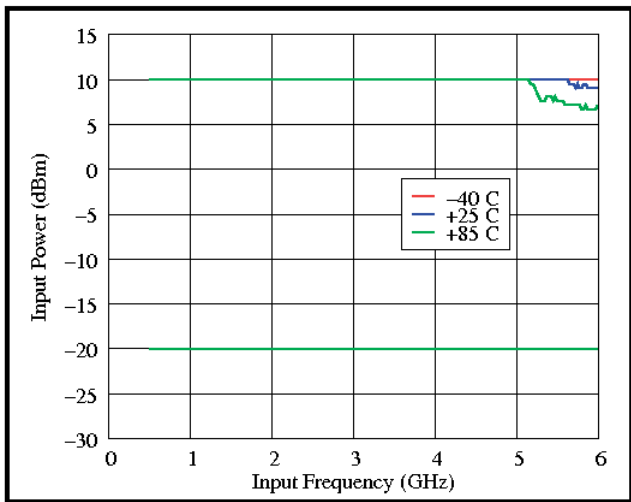
UXN6M9P Performance Plots



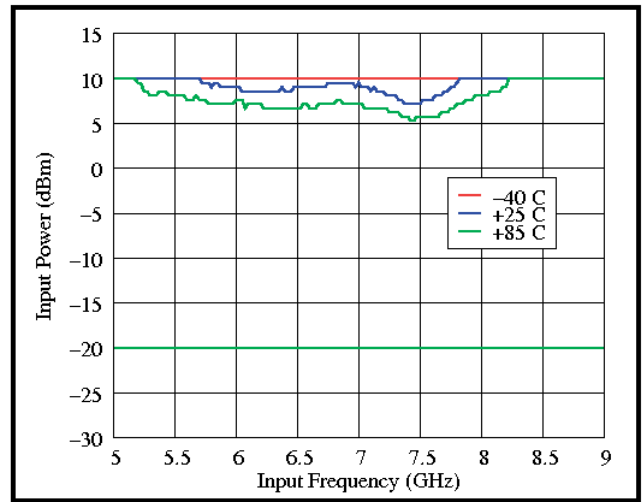
Min/Max Single-Ended Input Power, INP*
Input Sensitivity, T=25C, Divide-by-10, FRS=0



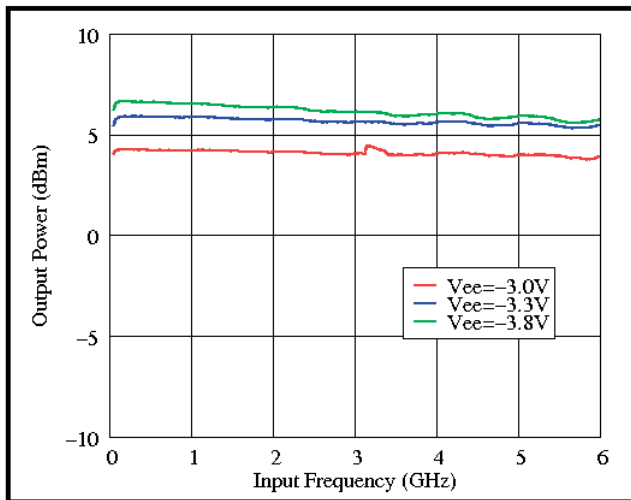
Min/Max Single-Ended Input Power, INP*
Input Sensitivity, T=25C, Divide-by-10, FRS=1



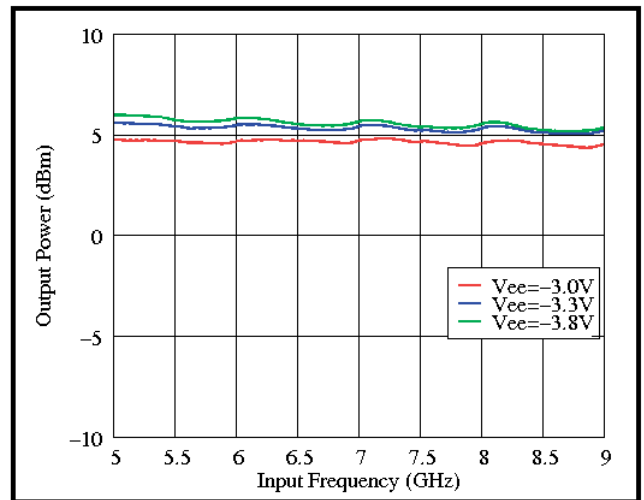
Min/Max Single-Ended Input Power, INP*
Input Sensitivity, -3.3V, Divide-by-10, FRS=0



Min/Max Single-Ended Input Power, INP*
Input Sensitivity, -3.3, Divide-by-10, FRS=1

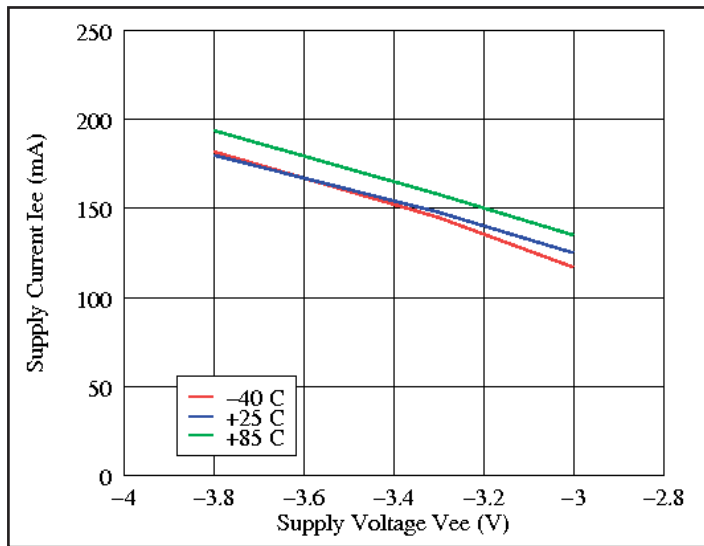


Output Power
Divide-by-10, FRS=0

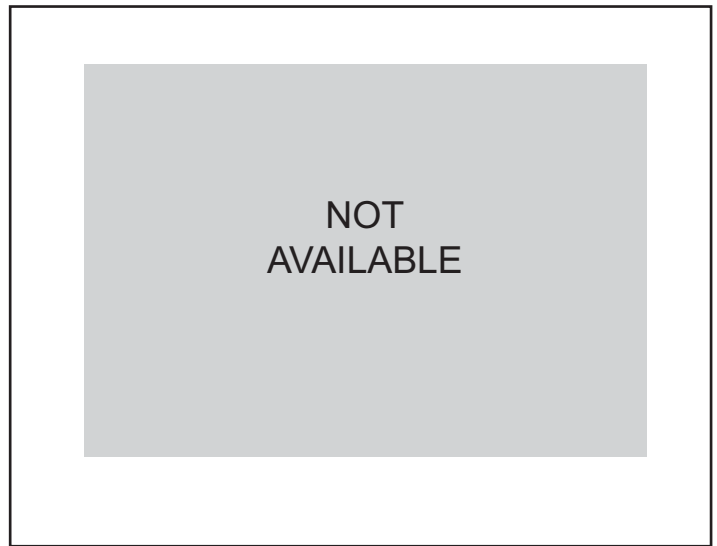


Output Power
Divide-by-10, FRS=1

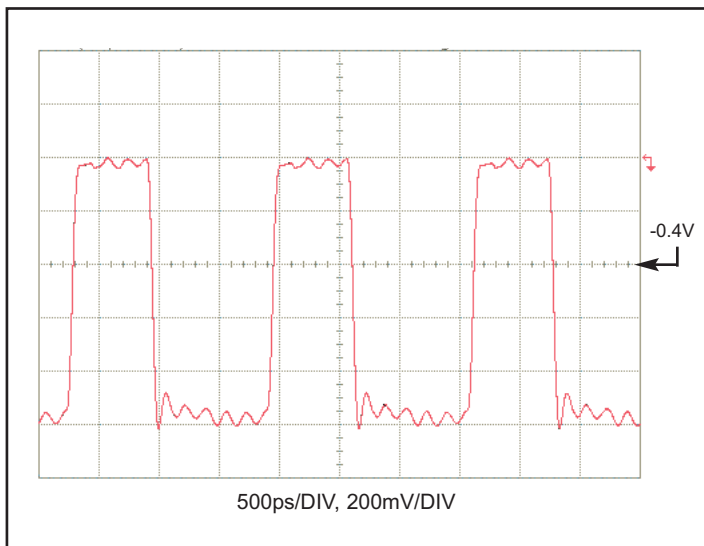
* NOTE: INP is recommended over INN in single-ended applications.



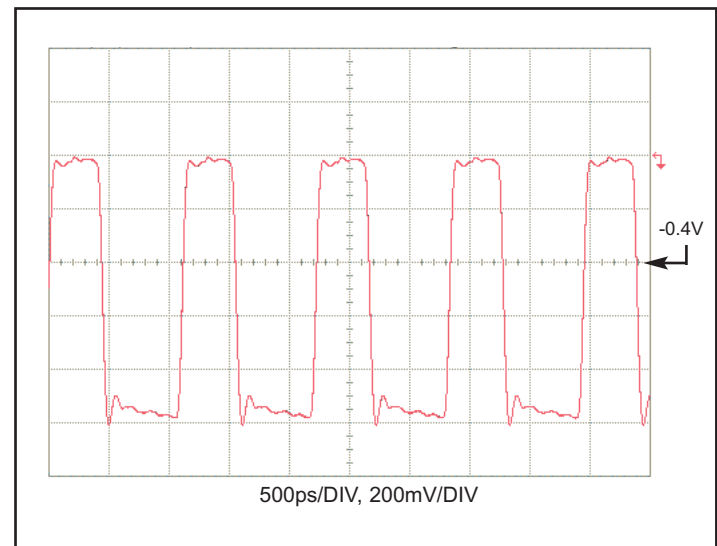
Nominal Supply Current Variation Versus Temperature and Supply Voltage



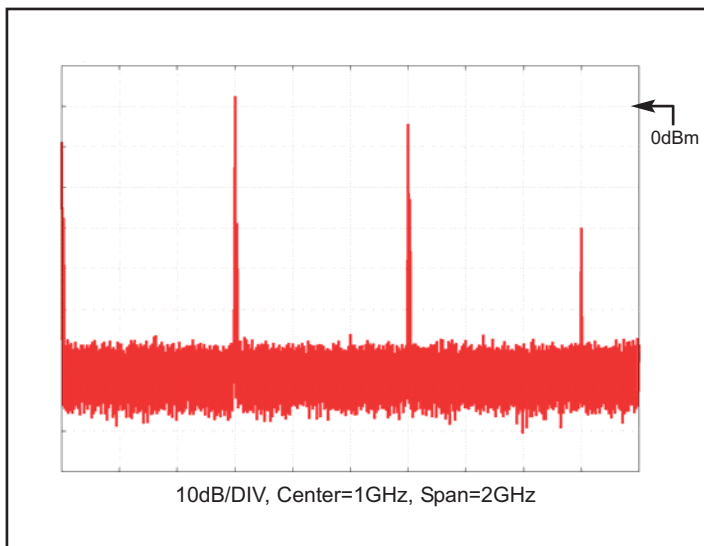
Phase Noise (To be determined)



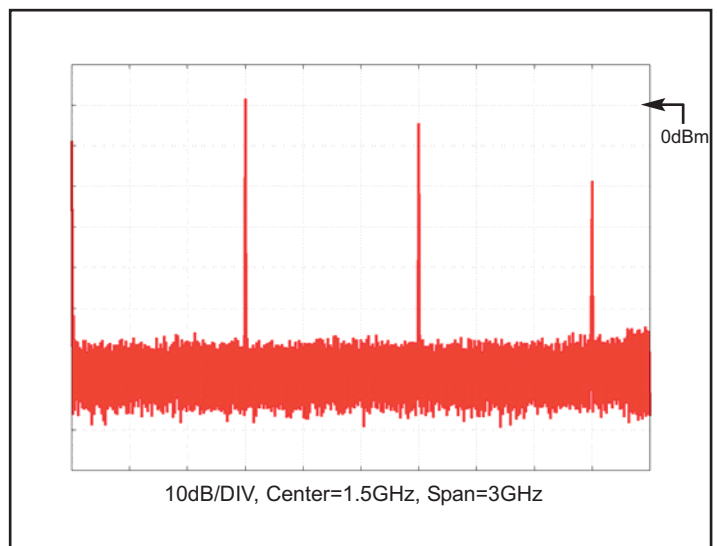
Waveform, Static Divide-by-10 Configuration
Input Freq = 6 GHz, FRS=0



Waveform, Static Divide-by-10 Configuration
Input Freq = 9 GHz, FRS=1

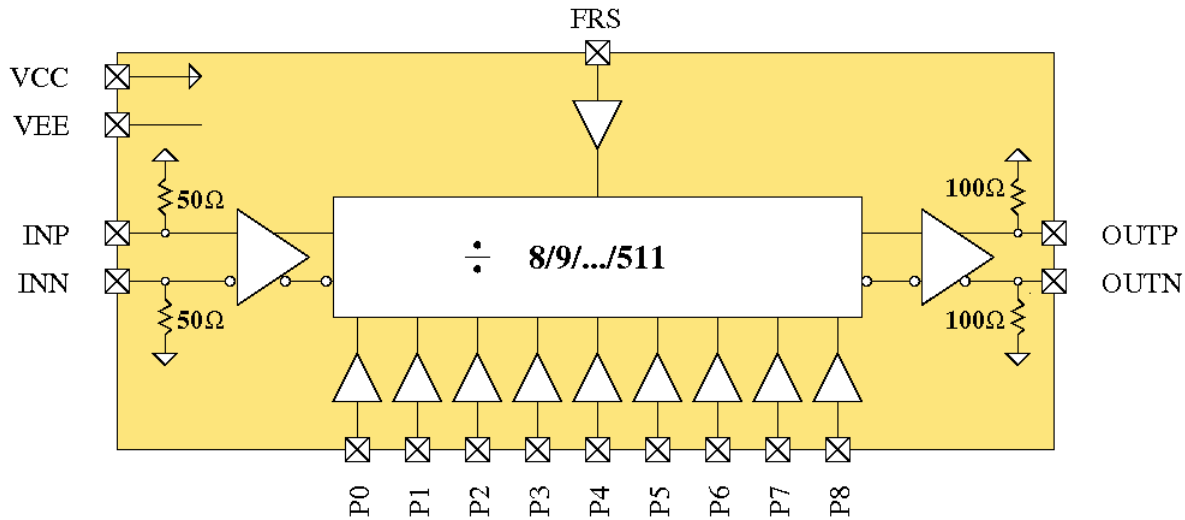


Spectrum, Static Divide-by-10 Configuration
Input Freq = 6 GHz, FRS=0



Spectrum, Static Divide-by-10 Configuration
Input Freq = 9 GHz, FRS=1

Functional Block Diagram



Pin Description

Port Name	Description	Additional Comments
INP	Divider Input, Positive Terminal	Negative CML signal levels
INN	Divider Input, Negative Terminal	Negative CML signal levels
OUTP	Divider Output, Positive Terminal	Negative CML signal levels
OUTN	Divider Output, Negative Terminal	Negative CML signal levels
P0-P8	Divider Modulus Control (P8=MSB)	Negative CMOS levels, see Equation 1, defaults to logic 0
FRS	Frequency Range Selector	Negative CMOS level, defaults to logic 0, see page 9
VCC	RF & DC Ground	Positive Supply Voltage
VEE	-3.3V @ 140mA	Negative Supply Voltage

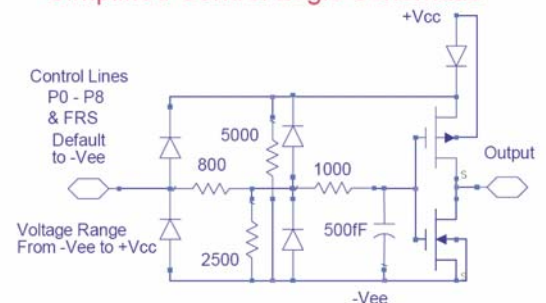
Equation 1

$$\text{Divider Modulus} = N = P_0 \cdot 2^0 + P_1 \cdot 2^1 + P_2 \cdot 2^2 + \dots + P_8 \cdot 2^8 \quad \text{for } 8 \leq N \leq 511$$

Negative CMOS Levels for control lines P0-P8

Logic Level	Minimum	Typical	Maximum
1 (High)	Vcc-1.25V	Vcc	Vcc
0 (Low)	Vee	Vee	Vee+1.25V

Simplified Control Logic Schematic



Application Notes

Low Frequency Operation

Low frequency operation is limited by external bypass capacitors and the slew rate of the input clock. The next paragraph shows the calculations for the bypass capacitors. If DC coupled, the device operates down to DC for square-wave inputs. Sine-wave inputs are limited to ~50MHz due to the 10dBm max input power limitation.

The values of the coupling capacitors for the high-speed inputs and outputs (I/O's) is determined by the lowest frequency the IC will be operated at.

$$C \gg \frac{1}{2 \cdot \pi \cdot 50\Omega \cdot f_{\text{lowest}}}$$

For example to use the device below 30kHz, coupling capacitors should be larger than 0.1uF.

IC Assembly

The device is designed to operate with either single-ended or differential inputs. Figures 1, 2 & 3 show the IC assembly diagrams for positive and negative supply voltages. In either case the supply should be capacitively bypassed to the ground to provide a good AC ground over the frequency range of interest. The backside of the chip should be connected to a good thermal heat sink.

All RF I/O's are connected to Vcc through on-chip termination resistors. This implies that when Vcc is not DC grounded (as in the case of positive supply), the RF I/O's should be AC coupled through series capacitors unless the connecting circuit can generate the correct levels through level shifting.

ESD Sensitivity

Although SiGe IC's have robust ESD sensitivities, preventive ESD measures should be taken while storing, handling, and assembling.

Inputs are more ESD susceptible as they could expose the base of a BJT or the gate of a MOSFET. For this reason, all the inputs are protected with ESD diodes. These inputs have been tested to withstand voltage spikes up to 400V.

Negative CML Logic Levels for DC Coupling (T=25 °C)

Assuming 50Ω Terminations at Inputs and Outputs

Parameter	Minimum	Typical	Maximum
Differential {	Logic Input _{high}	Vcc	Vcc
	Logic Input _{low}	Vcc - 0.05V	Vcc - 0.3V
Single {	Logic Input _{high}	Vcc + 0.05V	Vcc + 1V
	Logic Input _{low}	Vcc - 0.05V	Vcc - 0.3V
Differential & Single {	Logic Output _{high}	Vcc	Vcc
	Logic Output _{low}	Vcc - 0.2V	Vcc - 0.3V

Differential vs Single-Ended

The UXN6M9P is fully differential to maximize signal-to-noise ratios for high-speed operation. All high speed inputs and outputs are terminated to V_{CC} with on-chip resistors (refer to functional block diagram for specific resistor values). The maximum DC voltage on any terminal must be limited to V_{max} to prevent damaging the termination resistors with excessive current. Regardless of bias conditions, the following equation should be satisfied when driving the inputs differentially:

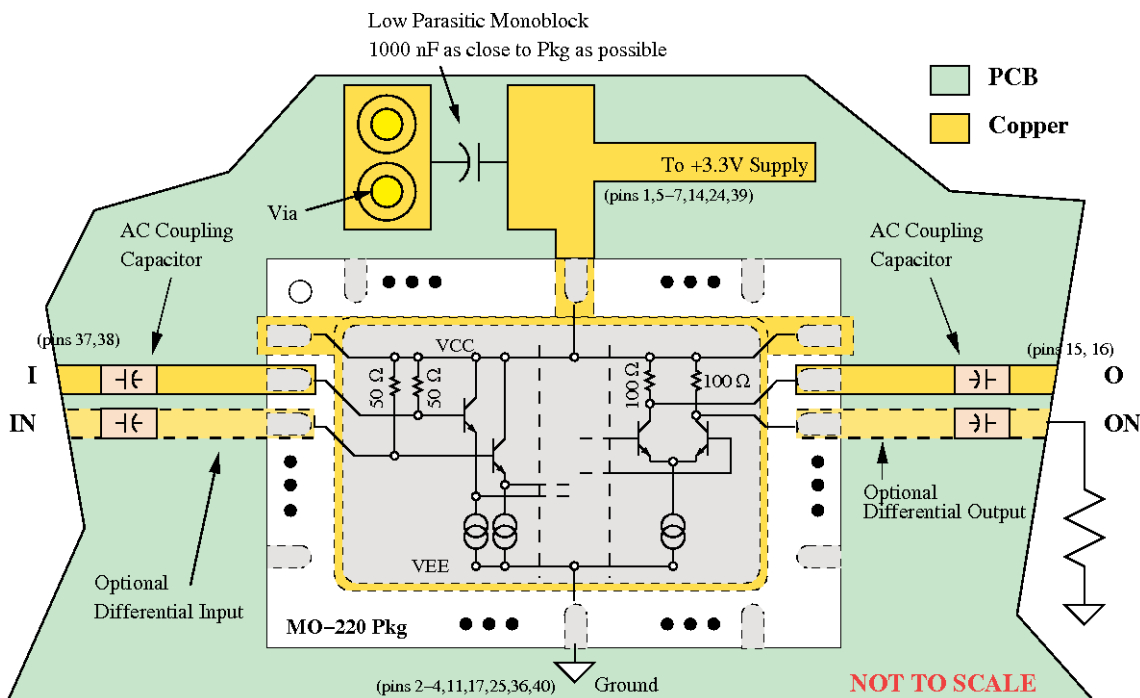
$$|V_{dm}/2 + V_{cm}| < V_{CC} \pm V_{max}$$

where V_{dm} is the differential input signal and V_{cm} is the common-mode voltage.

In addition to the maximum input signal levels, single-ended operation imposes additional restrictions: the average DC value of the waveform at IC should be equal to V_{CC} for single-ended operation. In practice, this is easily achieved with a single capacitor on the input acting as a DC block. The value of the capacitor should be large enough to pass the lowest frequencies of interest. Use the positive terminals for single-ended operation while terminating the negative terminal to V_{CC} .

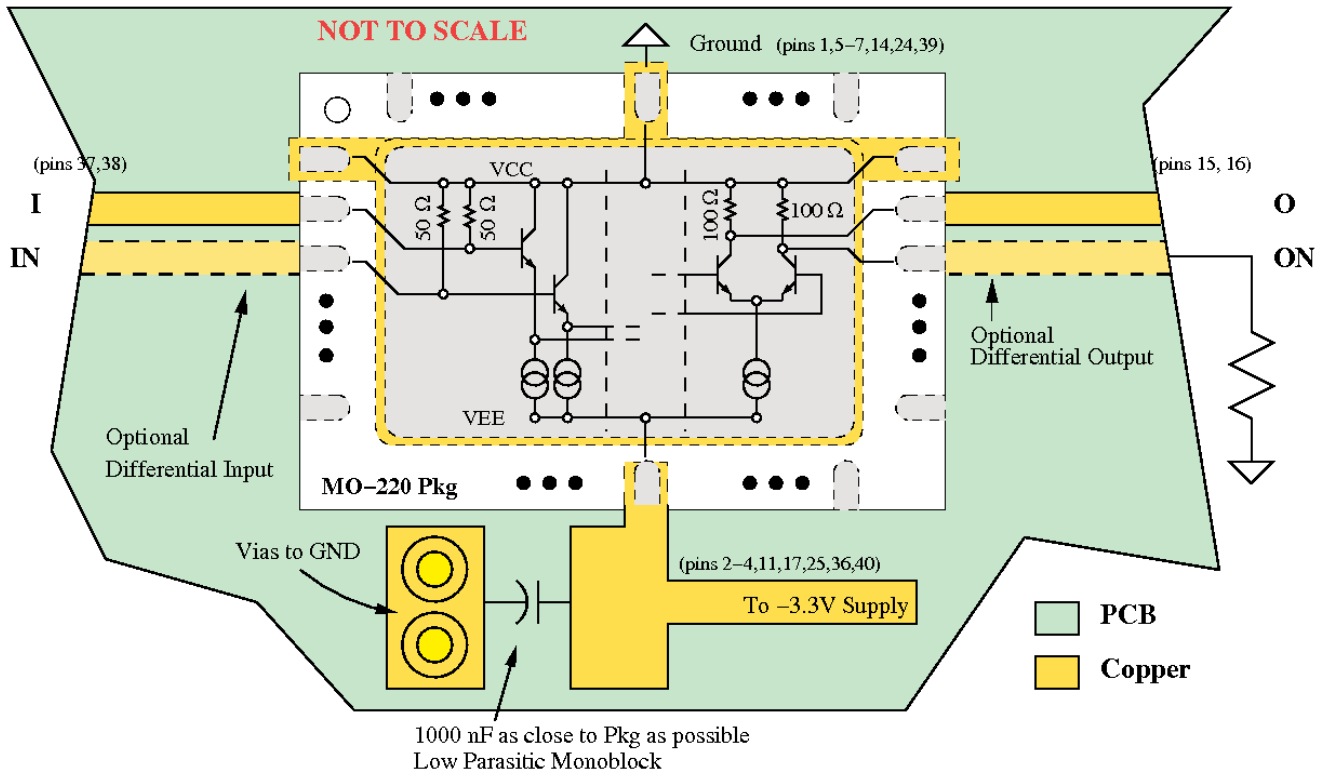
Note that a potential oscillation mechanism exists if both inputs are static and have identical DC voltages; a small DC offset on either input is sufficient to prevent possible oscillations. Tying unused inputs directly to V_{CC} shorts out the internal 50Ω bias resistor, imposing a DC offset sufficient to prevent oscillations. Driving the differential inputs with DC blocks, or driving the single-ended inputs without terminating unused inputs, is not recommended without taking additional steps to eliminate the potential oscillation issues.

Positive Supply (AC Coupling)

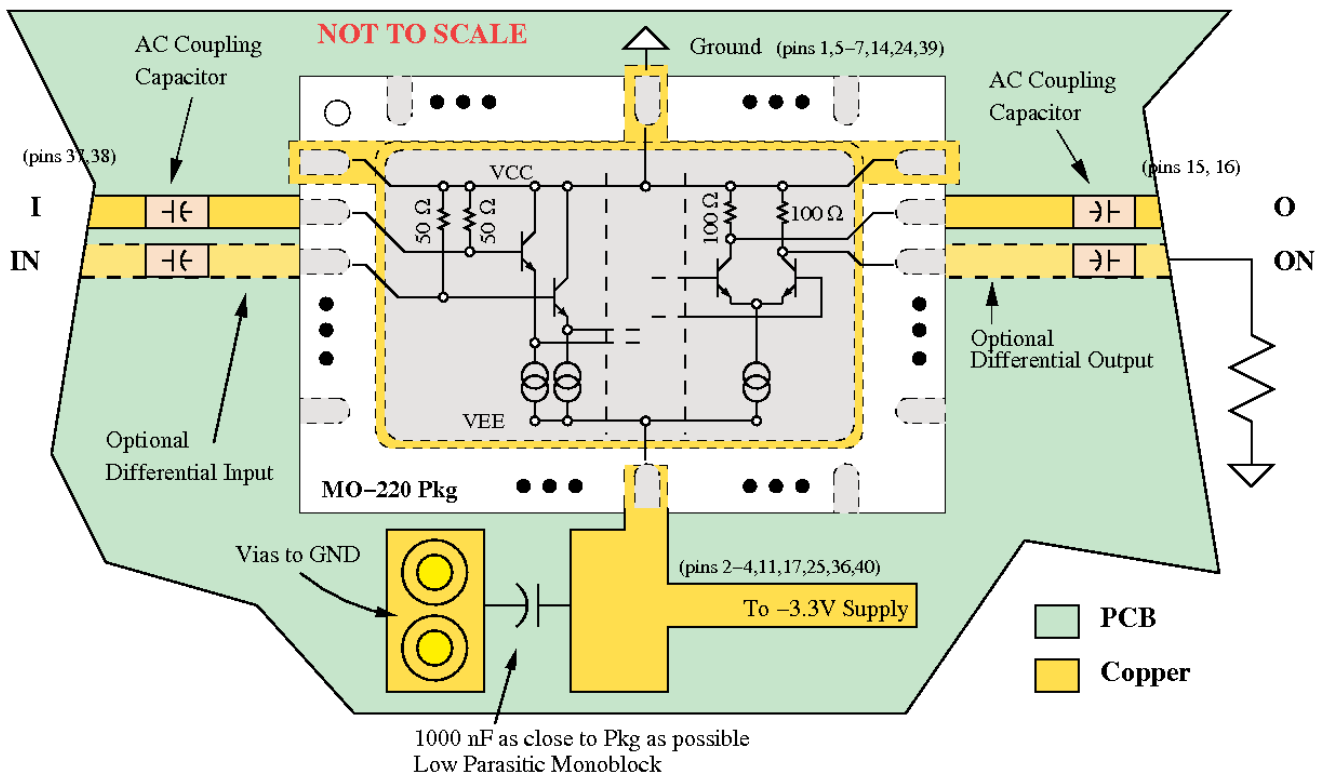


We recommend attaching the backside paddle to a good thermal heat sink.

Negative Supply (DC Coupling)



Negative Supply (AC Coupling)



Application Notes: Duty Cycle

The UXN6M9P output duty cycle varies between 25% and 64% as a function of the divide ratio. For divide ratios between 16 and 511, the pulse width remains constant in each octave band (e.g. between 128 and 255), and gives a duty cycle of 50% for powers of 2. Thus, the duty cycle is bounded between 25 and 50% for divide ratios between 16 and 511.

For divide ratios between 8 and 15, the pulse width does not stay fixed, but varies with the divide ratio. The duty cycle ranges from 33% to 64% for these divide ratios.

The table shown below gives pulse width and other necessary information for computing the duty cycle, given the divide ratio. The equation provided allows calculation of the duty cycle based on the information supplied by the table. A chart below summarizes the duty cycles for all possible divide ratios.

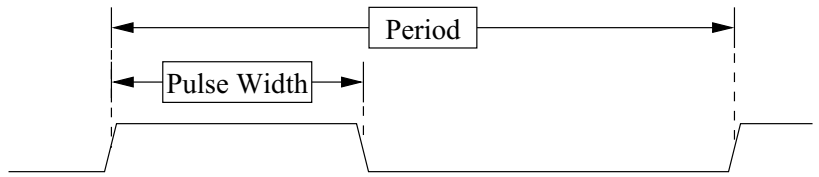
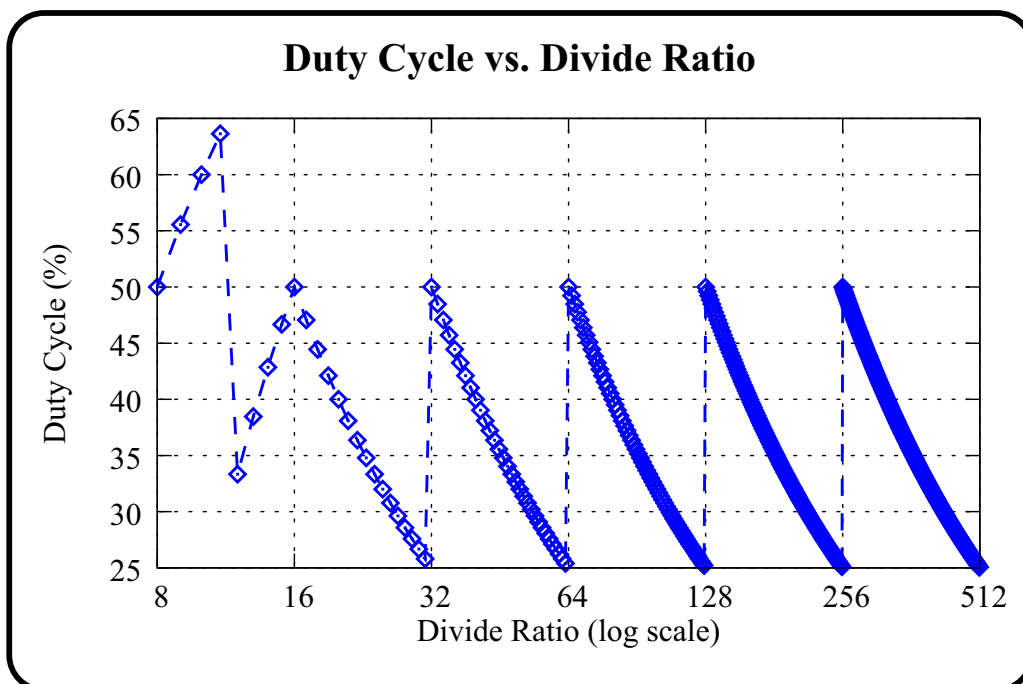


Table: Duty Cycle Summary

Divide Ratio	Pulse Width (Input Cycles)	Duty Cycle (%)
8	4	50
9	5	55.6
10	6	60
11	7	63.6
12	4	33.3
13	5	38.5
14	6	42.9
15	7	46.7
16-31	8	50-25
32-63	16	50-25
64-127	32	50-25
128-255	64	50-25
256-511	128	50-25

$$\text{Duty Cycle (\%)} = \frac{\text{Pulse Width}}{\text{Divide Ratio}} \times 100\%$$



Application Notes: Frequency Range Selector

The UXN6M9P includes an internal retimer using a clean signal $r(t)$ derived from the input clock in order to reduce jitter accumulated from passing through multiple divider stages. The UXN6M9P also features a frequency range selector control FRS for changing the phase of $r(t)$ by 180 degrees, or equivalently called a “clock flip”. This clock flip extends the maximum usable input frequency to 9 GHz. See the table provided on how to set FRS for the desired input frequency range.

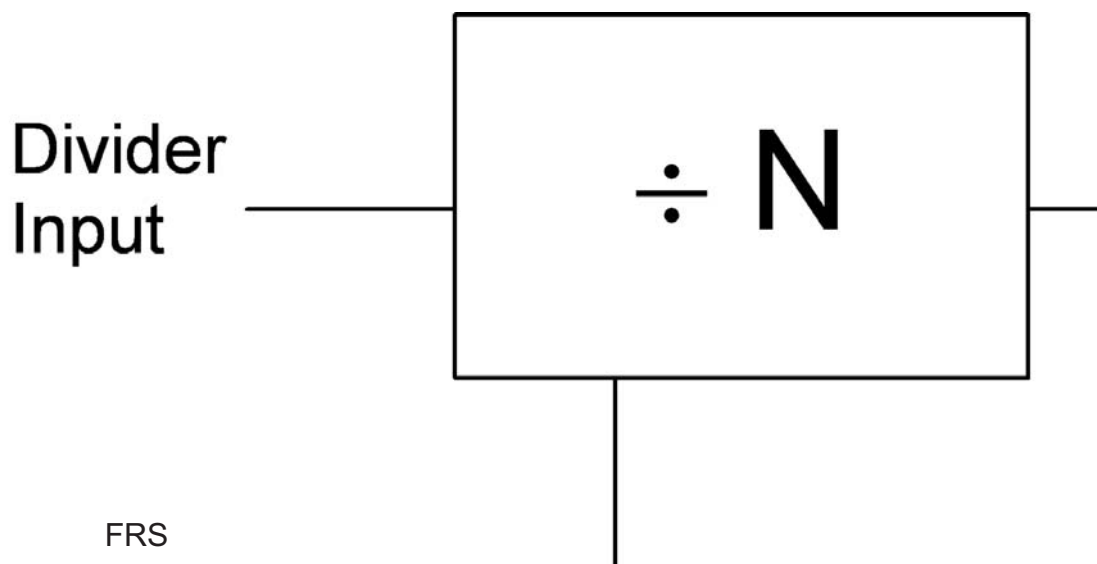


Table: Frequency Range Selector

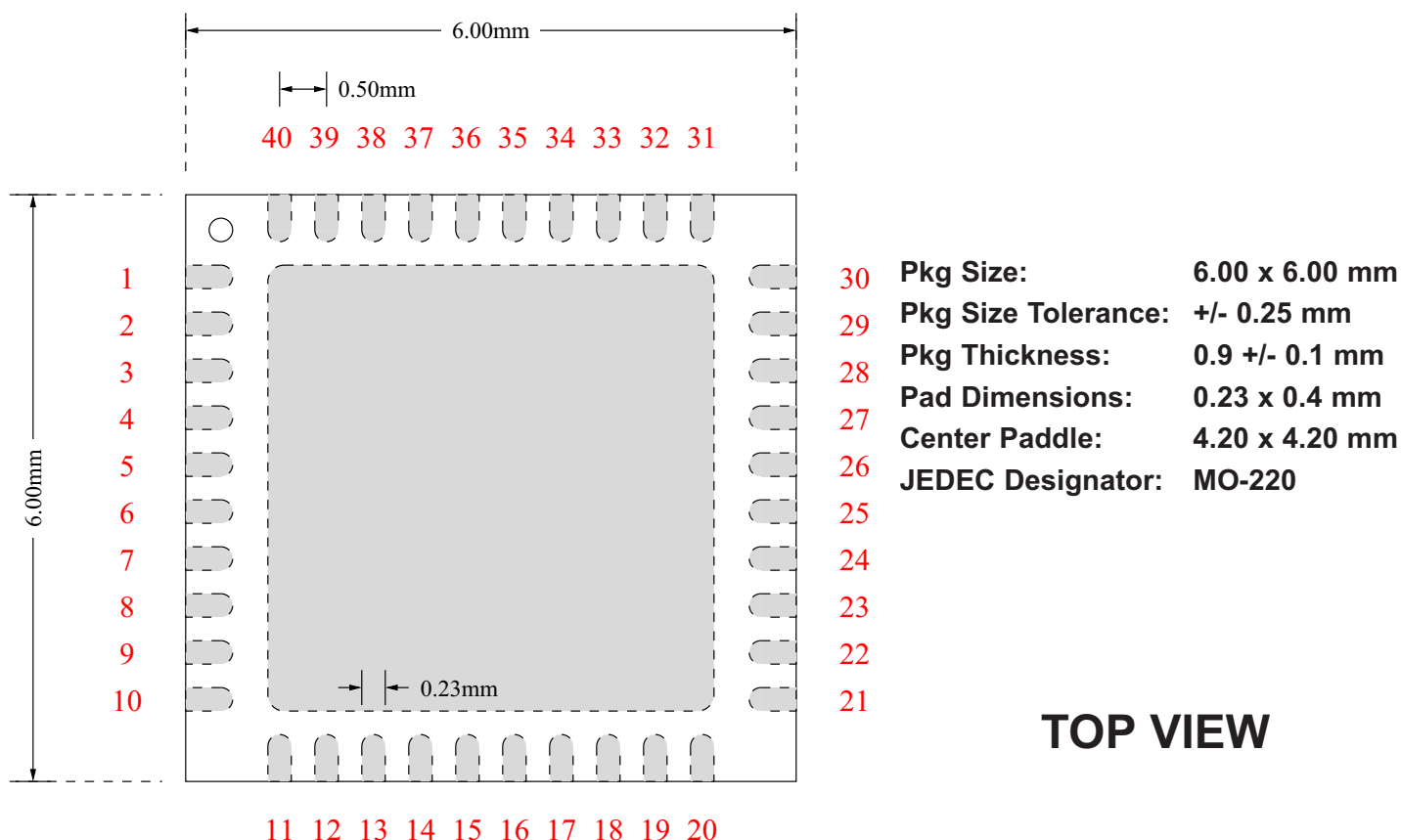
Input Frequency Range	FRS
DC - 6GHz	0
5 GHz - 9 GHz	1

Absolute Maximum Ratings

Parameter	Value	Unit
Supply Voltage (VEE)	-3.8	V*
RF input power (INP, INN)	+10	dBm
Operating Temperature	-40 to 85	°C
Storage Temperature	-85 to 125	°C

* This operating condition may reduce the lifetime of the part, and is not recommended.

UXN6M9P Physical Characteristics



UXN6M9P Pin Definition

Pin Function		Operational Notes
5-7,14,24,39 (Vcc)	RF and DC Ground	0V
2-4,11,17,25,36,40 (Vee)	Negative Supply Voltage	Nominally -3.3V
1 (FRS)	Frequency Range Selector	Defaults to logic 0, connect to Vcc for logic 1
15 (OUTN)	Divider Output	Negative Terminal of differential output
16 (OUTP)	Divider Output	Positive Terminal of differential output
26 (P8)	Divide Modulus Control (MSB)	Defaults to logic 0, connect to Vcc for logic 1
27 (P7)	Divide Modulus Control	Defaults to logic 0, connect to Vcc for logic 1
28 (P6)	Divide Modulus Control	Defaults to logic 0, connect to Vcc for logic 1
29 (P5)	Divide Modulus Control	Defaults to logic 0, connect to Vcc for logic 1
30 (P4)	Divide Modulus Control	Defaults to logic 0, connect to Vcc for logic 1
31 (P3)	Divide Modulus Control	Defaults to logic 0, connect to Vcc for logic 1
32 (P2)	Divide Modulus Control	Defaults to logic 0, connect to Vcc for logic 1
33 (P1)	Divide Modulus Control	Defaults to logic 0, connect to Vcc for logic 1
34 (P0)	Divide Modulus Control (LSB)	Defaults to logic 0, connect to Vcc for logic 1
37 (INN)	Divider Input	Negative Terminal of differential output
38 (INP)	Divider Input	Positive Terminal of differential output
Paddle	Floating	Tie to ground for heat dissipation
8-10,12,13,18-23,35(NC)	Floating Pins	